PRELIMINARY DATA SHEET

53253

RADIATION TOLERANT, 90V - 0.8A DUAL POWER MOSFET OPTOCOUPLERS



Features:

- Designed for 100 krad(Si) Total Dose
- 8-Pin Dual-In-Line Hermetic Package
- Performance over –55°C to +125°C
- Compact Isolation Solid State Switches
- Continuous Output Current: 0.8 A (1)
- Optically Coupled between Input and Output
- Isolation Tested to 1000 VDC
- High Level of Transient Immunity
- 3 A Output Surge Current
- Shock and Vibration Resistant
- MIL-PRF-38534 screening optional

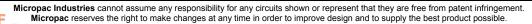
Applications:

- Satellite/Space systems
- Military/High Reliability Systems
- Standard 28 VDC and 48 VDC Load Driver
- Aircraft Controls
- Electromechanical and Solid State Relay Replacement
- I/O Modules
- Switching Heaters

DESCRIPTION

The 53253 is two power MOSFET optocouplers in a single 8-pin dual-in-line package suitable for applications where two independent switches and radiation tolerant performance are required. The popular hermetic eight-pin dual-in-line ceramic package combined with 1000 VDC isolation between input and output and between two isolated relays, makes this device ideal for solid-state relay applications. Performance is specified over the full military temperature range. This device is available as COTS, or screened to MIL-PRF-38534, Table C-IX, Class H or custom screening. Lead options support both through-hole and surface-mount assembly. Gold plated leads are standard, but other lead finishes per MIL-PRF-38534 are also available.

Functionally, the device operates as two SPST, normally open (2 Form A) solid-state relays. Each relay is actuated by an input current, which can be driven from a standard TTL device. The input current biases a light emitting diode that is optically coupled to an integrated photovoltaic diode array. The photovoltaic diode array energizes control circuitry that operates the output MOSFET.



ABSOLUTE MAXIMUM RATINGS:

(Per relay unless otherwise noted)

Storage Temperature Range Operating Ambient Temperature - T _A	
Junction Temperature - T _J Lead Solder Temperature for 10 seconds	+150°C
	(1.6 mm below seating plane)
Average Input Current - I _F Peak Repetitive Input Current - I _{Fpk}	40 mA
Peak Surge Input Current - I _{Fpk} surge	(pulse width < 100 ms; duty cycle < 50%)
Continuous Output Current per relay - I _O	(pulse width < 0.2 ms; duty cycle < 0.1%)
Single Shot Output Current per relay- I _{Opk} surge (pulse width < 10 ms) Output Voltage - V _O	3 A

RECOMMENDED OPERATING CONDITIONS:

Parameter	Symbol	Min.	Max.	Units
Input Current (ON)	I _{F (ON)}	5	20	mA
Input Voltage (OFF)	V _{F (OFF)}	0	0.6	VDC
Operating Temperature	T _A	-55	+125	°C

ELECTRICAL SPECIFICATIONS (Pre-Irradiation)

 $T_A = -55$ °C to +125°C, unless otherwise specified.

Parameter	Symbol	Min.	Тур.*	Max.	Unit s	Test Conditions	Notes
Output Withstand Voltage	$V_{O(OFF)}$	90			V	$V_F = 0.6 \text{ V}$ $I_O = 10 \mu\text{A}$	
Output On-Resistance	R _(ON)		0.6	1.2	Ω	I_F = 10 mA I_O = 0.8 A (pulse duration \leq 30 ms)	2
Output Leakage Current	I _{O (OFF)}			10	μА	$V_F = 0.6 V$ $V_O = 90 V$	
Input Forward Voltage	V_{F}	1.0	1.6	2.1	V	I _F = 10 mA	
Input Reverse Breakdown Voltage	V_R	5			V	I _F = 10 μA	
Input-Output Isolation	I _{I-O}			1	μА	RH \leq 45%, t = 5 s V _{I-O} = 1000 VDC T _A = 25°C	3
Channel-channel Isolation	I _{ISO}			1	μА	RH \leq 45%, t = 5 s V _{ISO} = 1000 VDC T _A = 25°C	3
Turn-On Time	t _{ON}			6	ms	$I_F = 10 \text{ mA}$ $V_O = 28 \text{ V}$ $I_O = 0.8 \text{ A}$	
Turn-Off time	t _{OFF}			2	ms	I _F = 10 mA V _O = 28 V I _O = 0.8 A	

^{*} All typical values are at $T_A = 25$ °C, $I_{F(ON)} = 10$ mA, $V_{F(OFF)} = 0.6$ V unless otherwise specified.

Notes:

- 1. Maximum average current rating where the case temperature (T_C) is maintained below 120°C.
- 2. During the pulsed R_{ON} measurement (I_O duration < 30 ms), ambient (T_A) and case temperature (T_C) are equal.
- 3. This is a momentary withstand test, not a continuous operating condition.
- Typical junction to case thermal resistance (θ_{JC}) for the device is 15°C/W, where case temperature (T_C) is measured at the center of the package bottom.

CAUTION:

Care should be taken not to exceed the maximum output power dissipation, maximum case temperature, and maximum junction temperature when repetitively switching loads.

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Micropac reserves the right to make changes at any time in order to improve design and to supply the best product possible.

Terminal number	Terminal Symbol
1	+IN 1
2	- IN 1
3	- OUT 2
4	+OUT 2
5	+IN 2
6	- IN 2
7	- OUT 1
8	+OUT 1

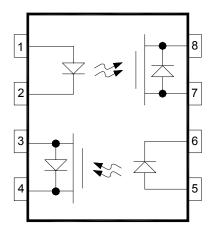


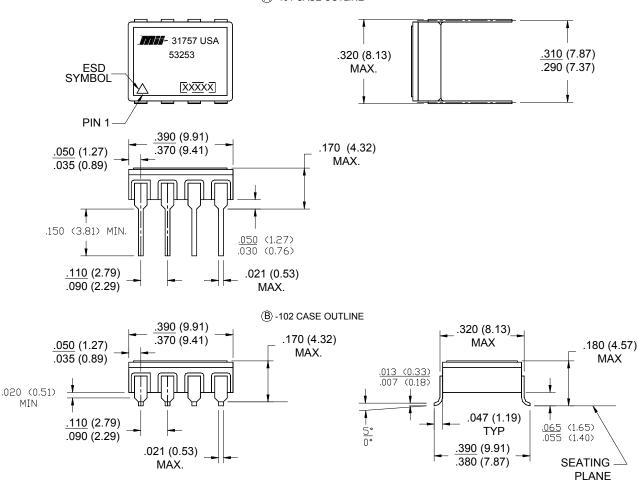
Figure 1 - Terminal Connections

INPUT	OUTPUT
OFF	OFF
ON	ON

Figure 2 - Truth Table

Case Outlines

(A) -101 CASE OUTLINE



NOTES:

- 1. PIN 1 IS INDICATED BY THE ESD TRIANGLE MARKED ON THE LID OF THE PACKAGE.
- 2. DIMENSIONS ARE IN INCHES, (mm).
- 3. METRIC EQUIVALENTS ARE GIVEN FOR GENERAL INFORMATION ONLY.
- 4. UNLESS OTHERWISE SPECIFIED, TOLERANCE IS ±.005 (0.13mm).